

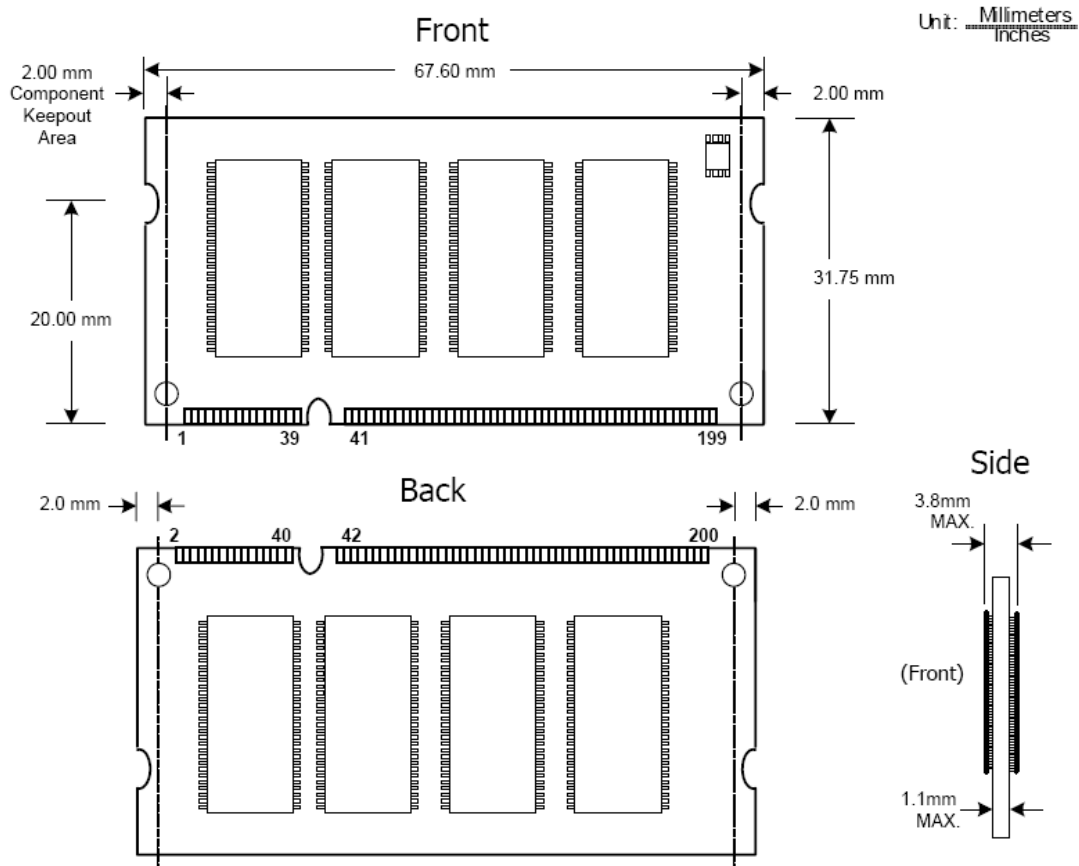
Memory Module Data Sheet L6464S36

512MB 64M x 64-bit DDR333 (PC2700) SoDIMM

SPECIFICATIONS;

- 512MB (64M x 64-bit) Unbuffered DDR333 SoDIMM
- TSOP II 32M x 16 (8M x 16 bit x 4 Bank/200Mhz) x Eight DRAM
- 200-pin Small Outline Dual Inline memory module with Gold Plated Contacts
- Dimm Dimensions 67.6 x 31.75 x 3.8 (mm)
- Programmable CAS Latency Supported - CL 2, 2.5
- Row Cycle Time (tRC) - 60ns
- Auto Refresh Cycle Time (tRFC)- 72ns (min.)
- Row Active Time (tRAS) - 42ns
- Clock Cycle Time (tCK) - 6ns
- Power Supply Voltage - 2.5V (+/- .01V)
- Operating Temperature (TA) - 0~70 Celsius

PACKAGE DIMENSIONS



NOTE: The module described in this data sheet is one of several configurations available under this part number. All configurations are compatible but the DRAM combination and the module height may vary from what is described.